



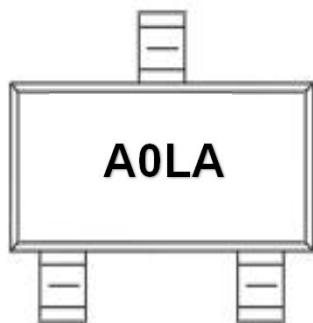
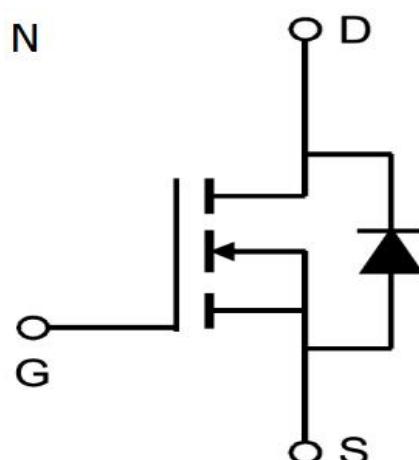
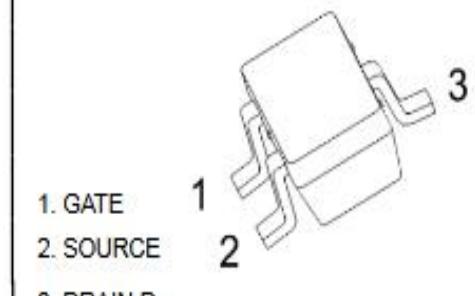
SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

SOT-23-3L Plastic-Encapsulate MOSFETS**MK3400A****N-Channel 30-V(D-S) MOSFET**

V(BR)DSS	RDS(on)MAX	ID
30 V	32mΩ@10V	5.8A
	35mΩ@4.5V	
	50mΩ@2.5V	

FEATURE

※ TrenchFET Power MOSFET

APPLICATION※ Load Switch for Portable Devices
※ DC/DC Converter**MARKING****Equivalent Circuit****SOT-23-3L****Maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _D S	30	V
Gate-Source Voltage	V _G S	±12	
Continuous Drain Current	I _D	5.8	A
Pulsed Diode Current	I _D M	30	
Continuous Source-Drain Current(Diode Conduction)	I _S	0.8	
Power Dissipation	P _D	1.4	W
Thermal Resistance from Junction to Ambient (t≤5s)	R _{θJA}	125	°C/W
Operating Junction	T _J	150	°C
Storage Temperature	T _{STG}	-55~+150	°C



MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics ($T_a = 25^\circ C$ Unless Otherwise Noted)

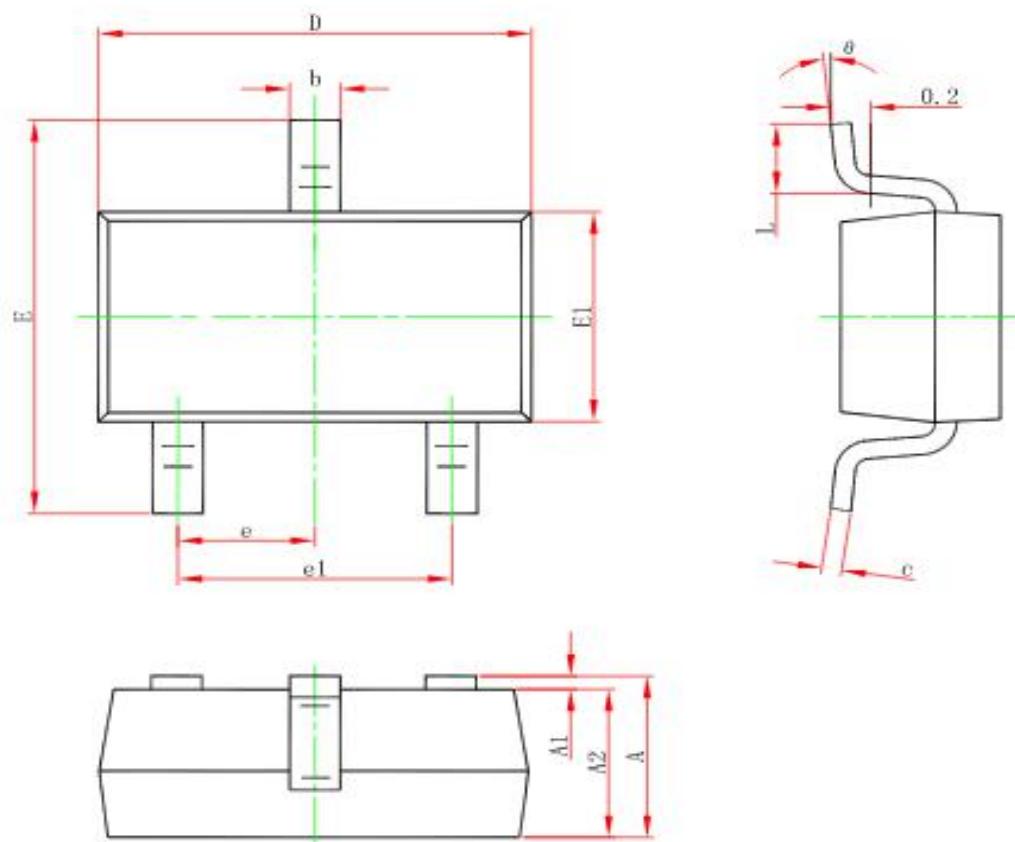
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	$V_{GS} = 0V, ID = 250\mu A$	30			V
Gate-source threshold voltage	VGS(th)	$V_{DS} = V_{GS}, ID = 250\mu A$	0.6		1.2	V
Gate-source leakage	IGSS	$V_{DS} = 0V, V_{GS} = \pm 12V$			± 100	nA
Zero gate voltage drain current	IDSS	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Drain-source on-state resistancea	RDS(on)	$V_{GS} = 10V, ID = 5.8A$		25	32	$m\Omega$
		$V_{GS} = 4.5V, ID = 4.8A$		27	35	$m\Omega$
		$V_{GS} = 2.5V, ID = 4.0A$		39	50	$m\Omega$
Forward transconductancea	gfs	$V_{DS} = 4.5V, ID = 5A$		15		S
Diode forward voltage	VSD	$IS=1A, VGS=0V$		0.7	1.3	V
Dynamic						
Input capacitance	Ciss	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$		823	1050	pF
Output capacitance	Coss			99		pF
Reverse transfer capacitanceb	Crss			77		pF
Total gate charge	Qg	$V_{DS} = 10V, V_{GS} = 4.5V, ID = -5.8A$		11	14	nC
Gate-source charge	Qgs			1.3		nC
Gate-drain charge	Qgd			2.8		nC
Gate resistance	Rg	f=1MHz			3.6	Ω
Switchingb						
Turn-on delay time	td(on)	$V_{DD} = 10V, RL = 10\Omega, ID \approx 1A, V_{GEN} = 4.5V, R_g = 6\Omega$		7	15	ns
Rise time	tr			15	20	ns
Turn-off delay time	td(off)			38	50	ns
Fall time	tf			3	10	ns
Drain-source body diode characteristics						
Continuous Source-Drain Diode Current	IS	$T_c = 25^\circ C$			1.2	A
Pulsed Diode forward Current	ISM				20	A

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t < 5$ sec.
3. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production testing.



SOT-23-3L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°



Typical Characteristics:

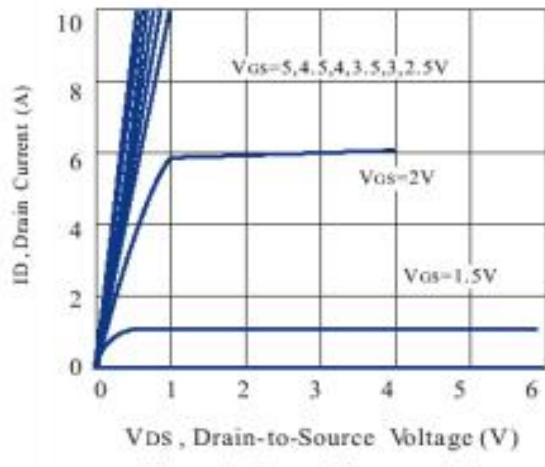


Figure 1. Output Characteristics

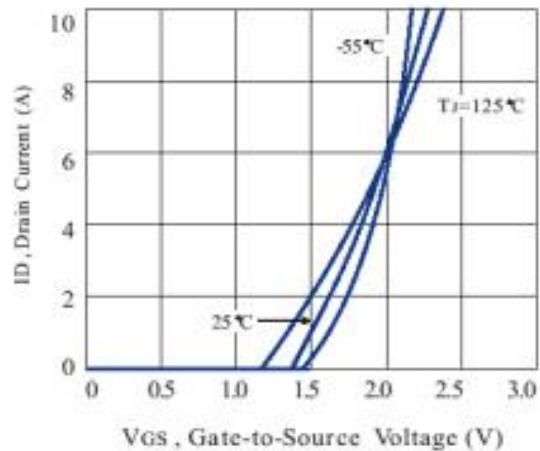


Figure 2. Transfer Characteristics

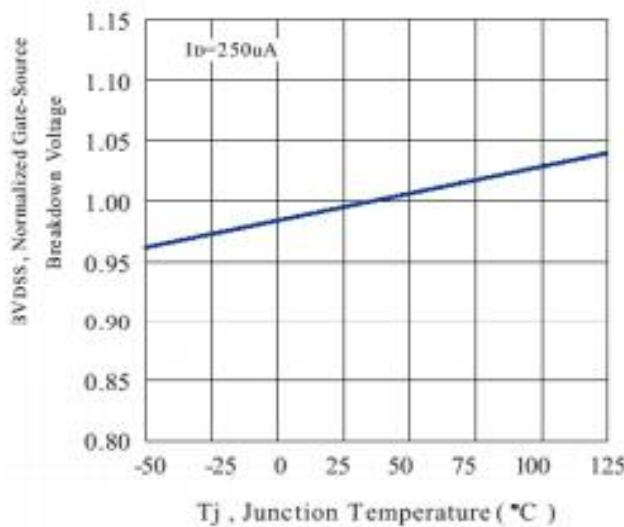


Figure 3. Breakdown Voltage Variation with Temperature

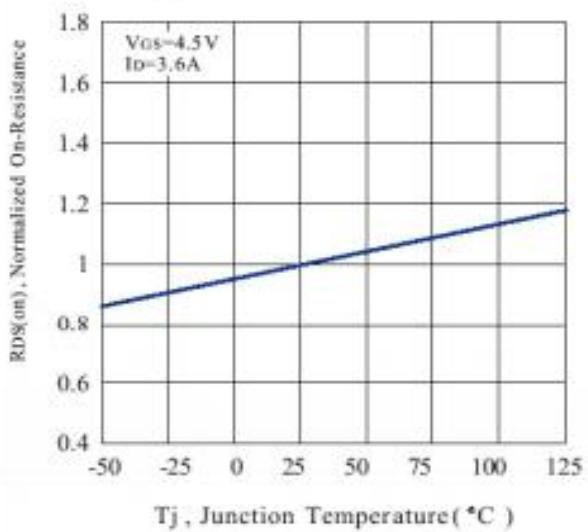


Figure 4. On-Resistance Variation with Temperature

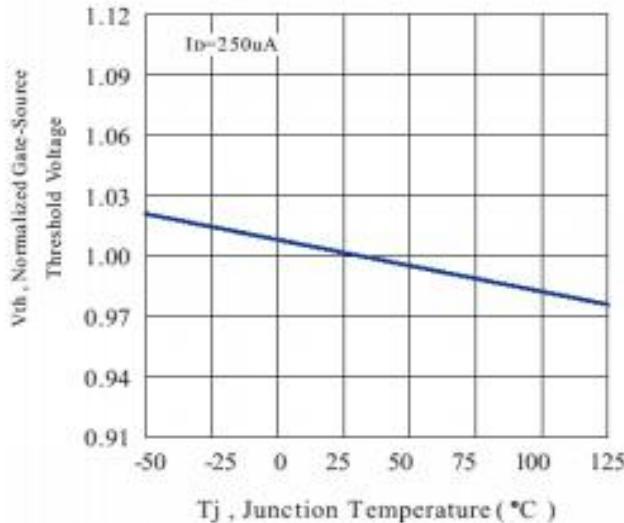


Figure 5. Gate Threshold Variation with Temperature

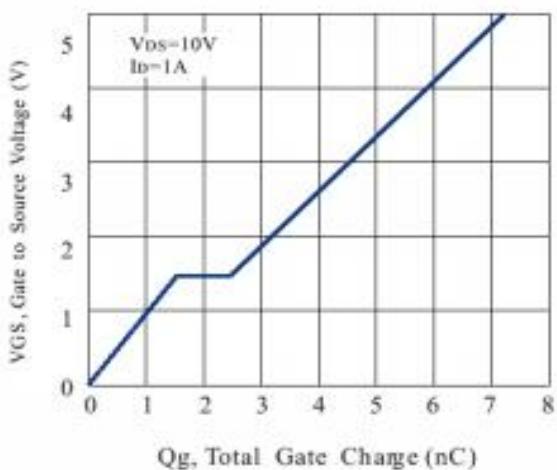


Figure 6. Gate Charge